
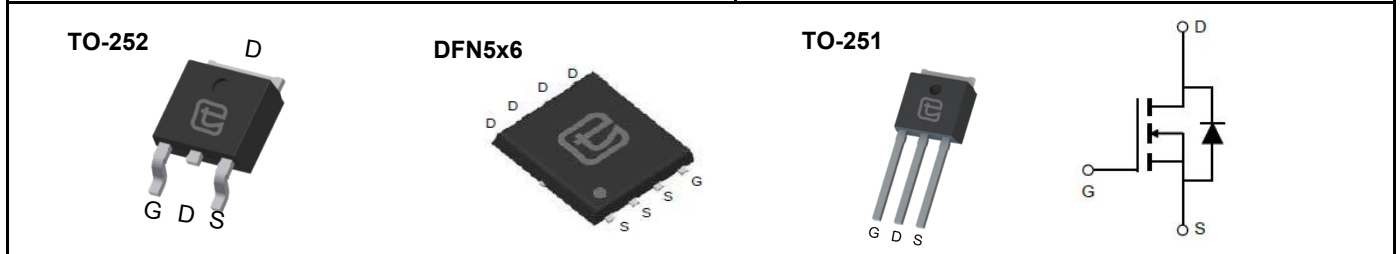




## 60V N-Channel SGT MOSFET

<p><b>General Description</b></p> <ul style="list-style-type: none"> <li>● Trench Power SGT technology</li> <li>● Very low on-resistance <math>R_{DS(ON)}</math></li> <li>● Low Gate Charge</li> <li>● Excellent Gate Charge x <math>R_{DS(ON)}</math> Product</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>● High Frequency Switching and Synchronous Rectification</li> </ul>	<p><b>Product Summary</b></p> <table border="0"> <tr> <td><math>V_{DS}</math></td> <td>60V</td> </tr> <tr> <td><math>I_D</math> (at <math>V_{GS}=10V</math>)</td> <td>45A</td> </tr> <tr> <td><math>R_{DS(ON)}</math> (at <math>V_{GS}=10V</math>)</td> <td>&lt; 15m<math>\Omega</math></td> </tr> </table> <p>100% UIS Tested</p> 	$V_{DS}$	60V	$I_D$ (at $V_{GS}=10V$ )	45A	$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 15m $\Omega$
$V_{DS}$	60V						
$I_D$ (at $V_{GS}=10V$ )	45A						
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 15m $\Omega$						



Part Number	Package Type	Form	Marking
TSD10N06A	TO-252	Tape & Reel	D10N06A
TSG10N06A	DFN5×6	Tape & Reel	G10N06A
TSU10N06A	TO-251	Tape & Reel	U10N06A

### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>B</sup>	$I_D$	$T_C = 25^\circ\text{C}$	45
		$T_C = 100^\circ\text{C}$	27
Pulsed Drain Current <sup>A</sup>	$I_{DM}$	180	A
Avalanche Current <sup>A</sup>	$I_{AS}$	20	A
Single Pulse Avalanche Energy $L = 0.3\text{mH}$ <sup>A</sup>	$E_{AS}$	20	mJ
Power Dissipation <sup>C</sup>	$P_D$	$T_C = 25^\circ\text{C}$	56.5
		$T_C = 100^\circ\text{C}$	35.7
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Case	$R_{\theta JC}$	2.1	$^\circ\text{C/W}$
Maximum Junction-to-Ambient			
	$R_{\theta JA}$	50	



Electrical Characteristics( $T_J = 25^\circ\text{C}$ unless otherwise noted)							
Symbol	Parameter	Conditions	Value			Units	
			Min	Typ	Max		
<b>STATIC PARAMETERS</b>							
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	60	--	--	V	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{V}, V_{GS} = 0\text{V}$	$T_J = 25^\circ\text{C}$	--	--	1	$\mu\text{A}$
			$T_J = 125^\circ\text{C}$	--	--	100	
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	--	--	$\pm 100$	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.5	--	4.0	V	
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 20\text{A}$	--	12	15	m $\Omega$	
$g_{FS}$	Forward Transconductance	$V_{DS} = 5\text{V}, I_D = 20\text{A}$	--	100	--	S	
$V_{SD}$	Diode Forward Voltage	$I_S = 1\text{A}, V_{GS} = 0\text{V}$	--	--	1	V	
$I_S$	Maximum Body-Diode Continuous Current <sup>B</sup>		--	--	30	A	
<b>DYNAMIC PARAMETERS</b>							
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 30\text{V}, f = 1\text{MHz}$	--	1134	--	$\mu\text{F}$	
$C_{oss}$	Output Capacitance		--	123	--		
$C_{rss}$	Reverse Transfer Capacitance		--	12	--		
<b>SWITCHING PARAMETERS</b>							
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, I_D = 20\text{A}$	--	21	--	nC	
$Q_{gs}$	Gate Source Charge		--	3.1	--		
$Q_{gd}$	Gate Drain Charge		--	5.1	--		
$t_{D(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, I_D = 20\text{A}, R_G = 3\Omega$	--	7	--	ns	
$t_r$	Turn-On Rise Time		--	3	--		
$t_{D(off)}$	Turn-Off Delay Time		--	20	--		
$t_f$	Turn-Off Fall Time		--	3	--		
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F = 20\text{A}, di/dt = 500\text{A}/\mu\text{s}$	--	17	--	ns	
$Q_{rr}$	Body Diode Reverse Recovery Charge		--	60	--	nC	

A. Single pulse width limited by maximum junction temperature.

B. The maximum current rating is package limited.

C. The power dissipation  $P_D$  is based on  $T_{J(MAX)} = 175^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

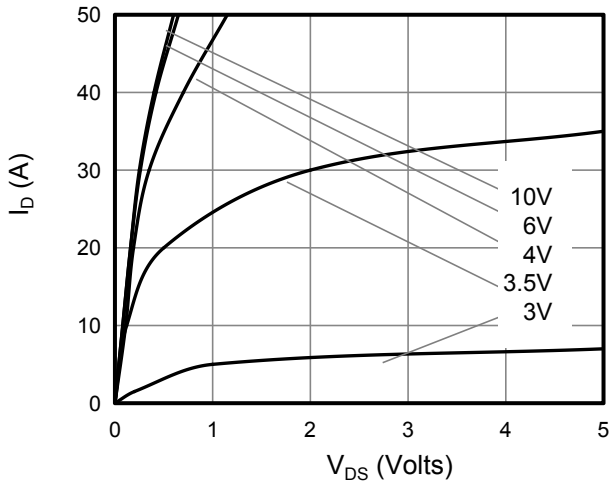


Figure 1: On-Region Characteristics

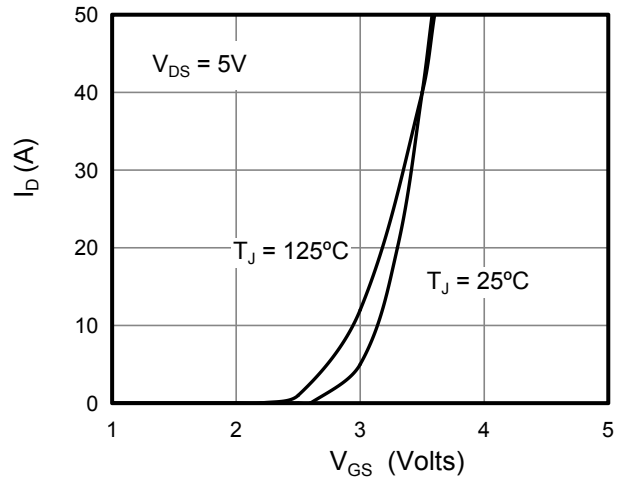


Figure 2: Transfer Characteristics

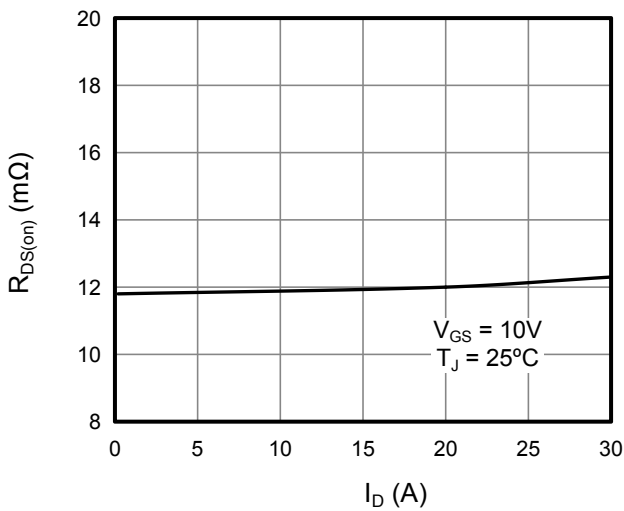


Figure 3: On-Resistance vs. Drain Current

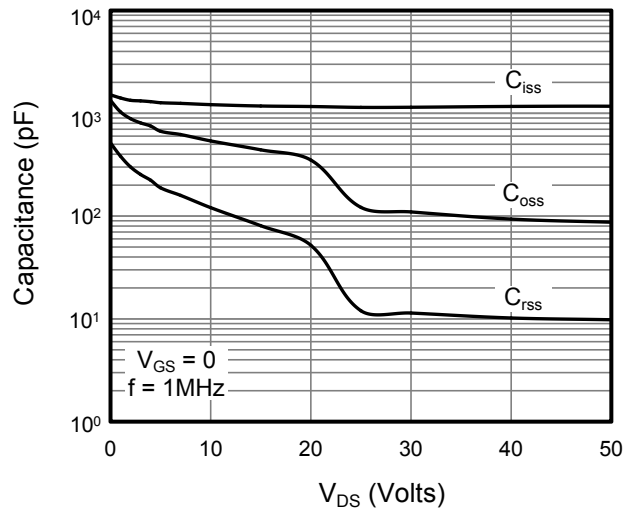


Figure 4: Capacitance Characteristics

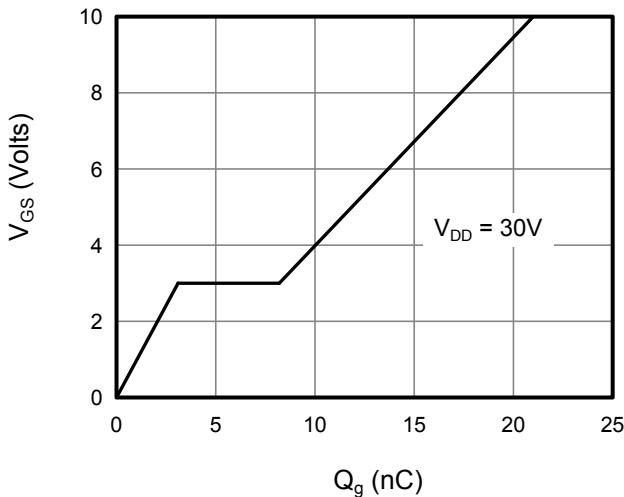


Figure 5: Gate Charge Characteristics

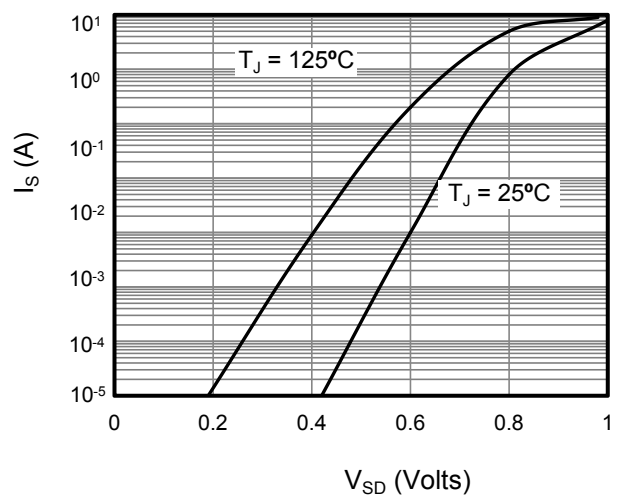


Figure 6: Body Diode Forward Voltage



Typical Characteristics  $T_j = 25^\circ\text{C}$ , unless otherwise noted

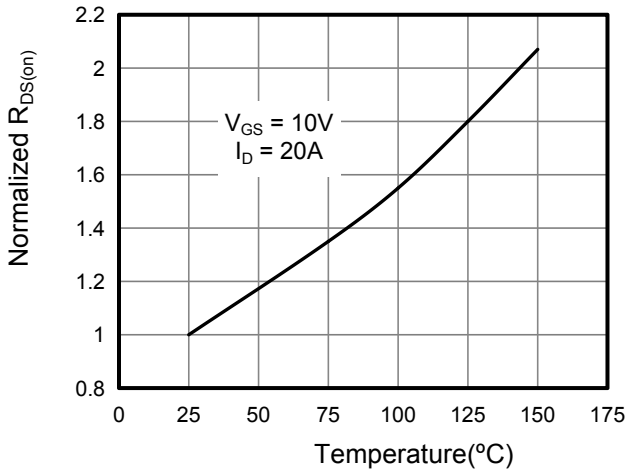


Figure 7: On-Resistance vs. Junction Temperature

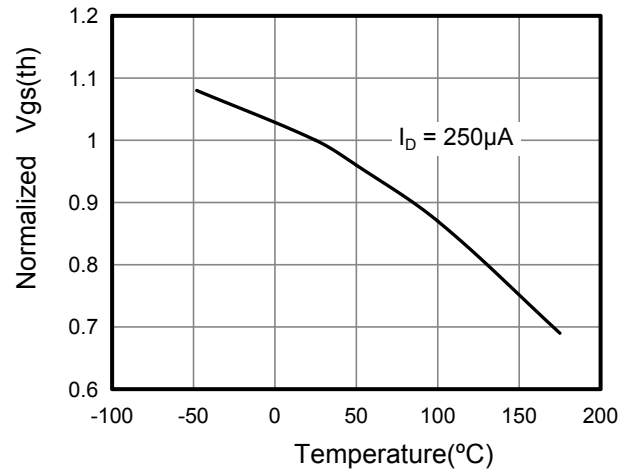


Figure 8:  $V_{GS(th)}$  vs. Junction Temperature

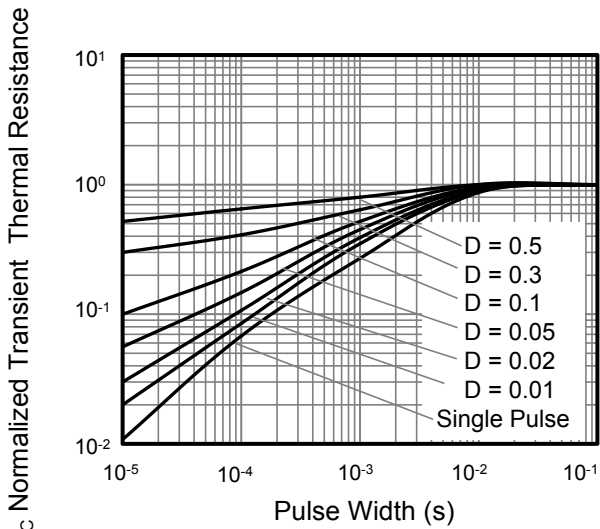


Figure 9: Normalized Transient Thermal Resistance

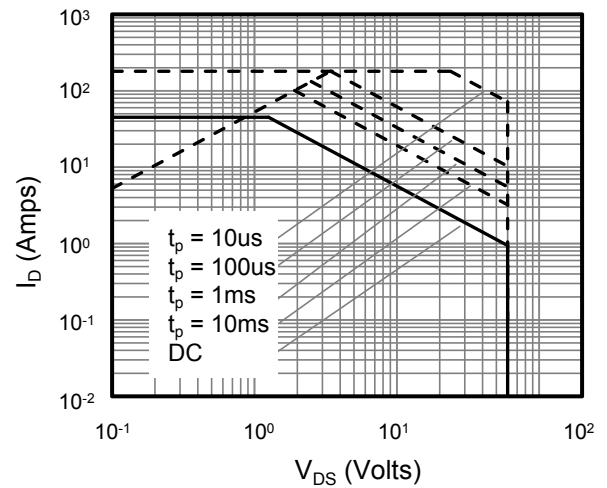


Figure 10: Safe Operating Area



Figure A: Gate Charge Test Circuit and Waveform

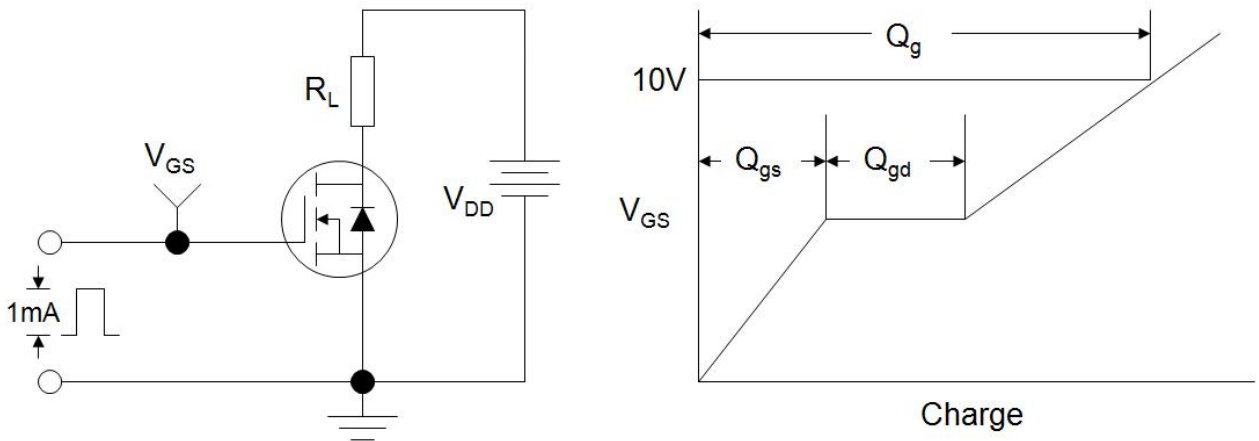


Figure B: Resistive Switching Test Circuit and Waveform

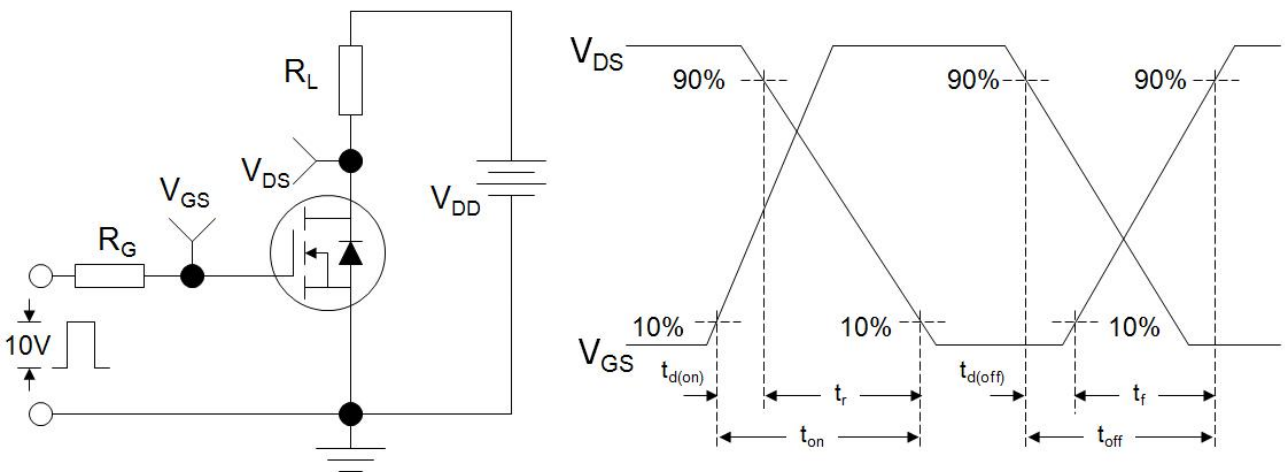
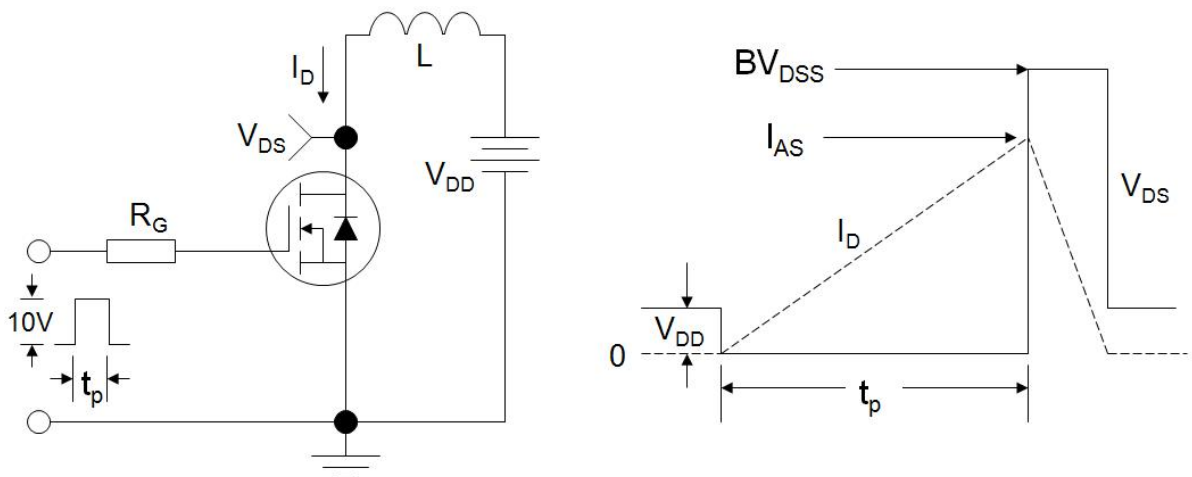
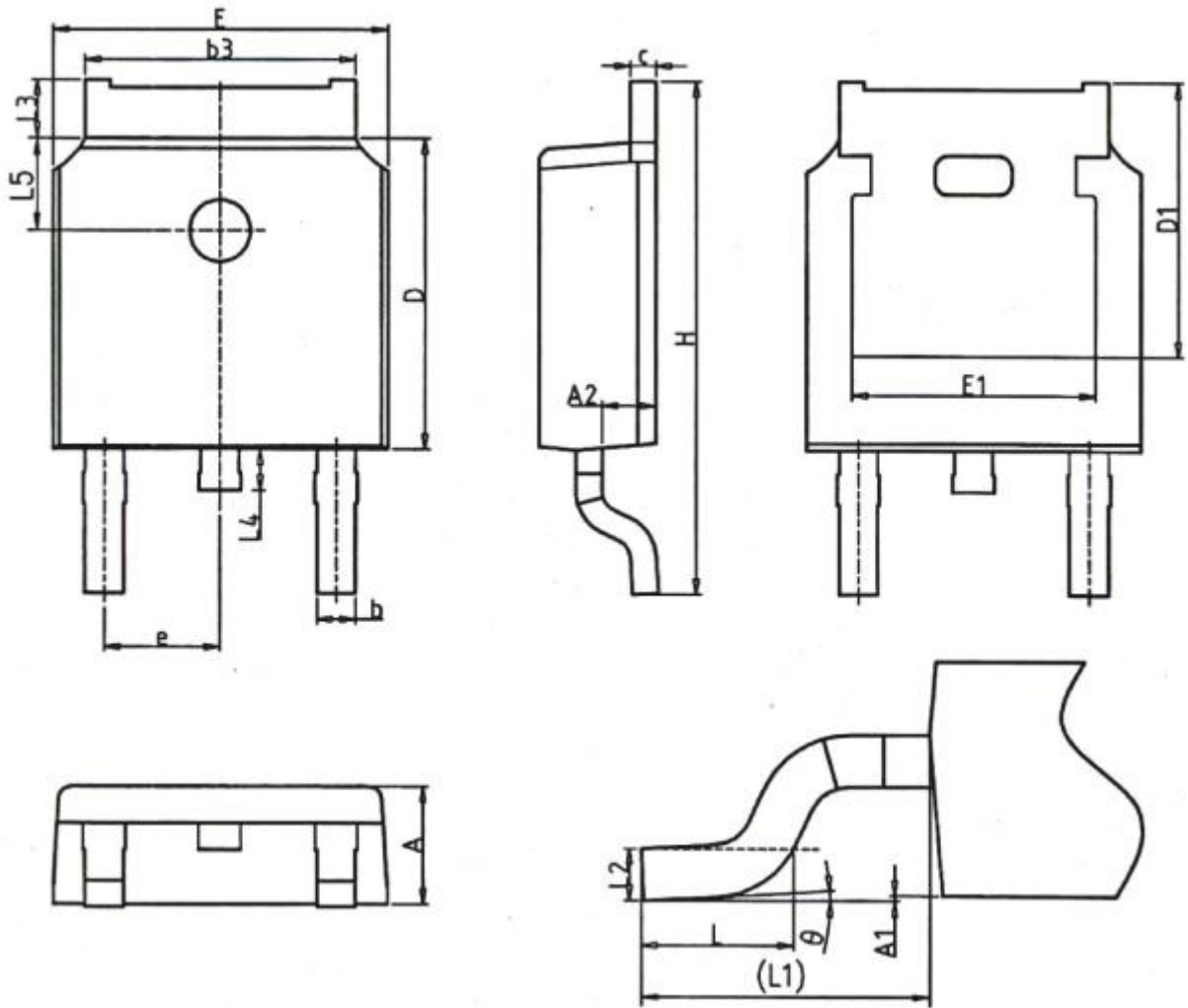


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





### TO-252 (华羿)

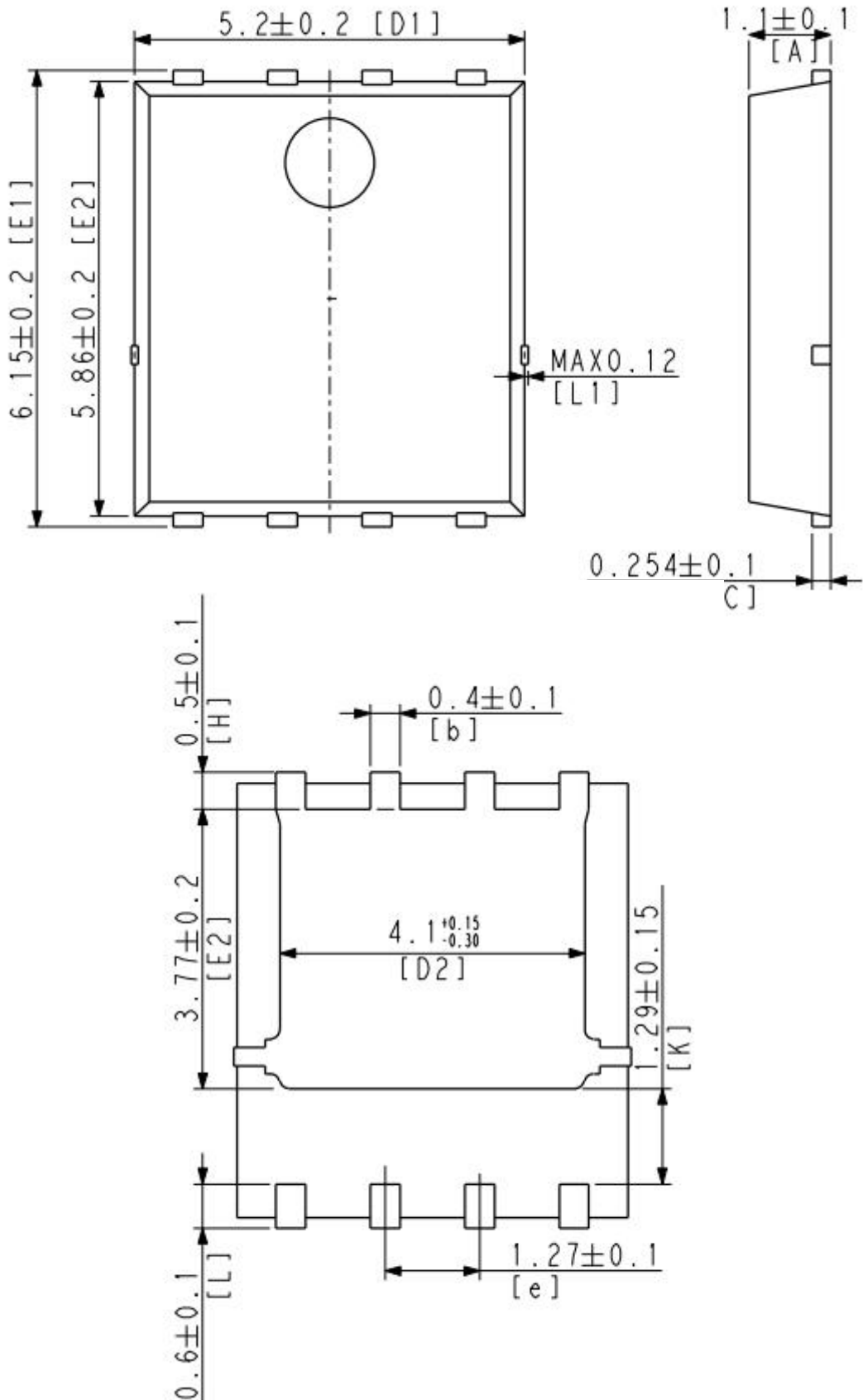


Unit:mm			
Symbol	Min.	Nom	Max.
A	2.20	2.30	2.38
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30 REF		
E	6.40	6.60	6.73
E1	4.63	-	-

Unit:mm			
Symbol	Min.	Nom	Max.
e	2.286 BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90 REF		
L2	0.51 BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
L5	1.65	1.80	1.95
θ	0°	-	8°

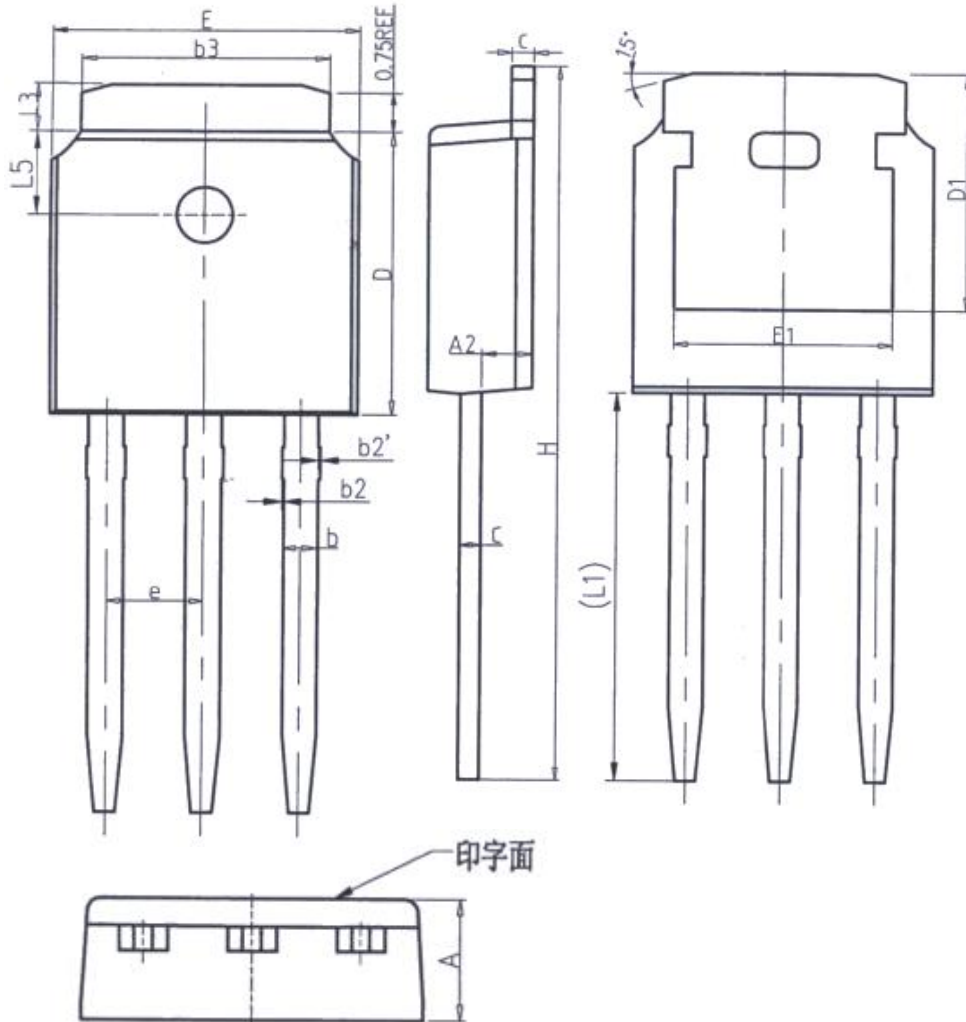


### DFN5x6 (华天)





### TO-251 (创立达)



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A2	0.97	1.17
b	0.68	0.90
b2	0.00	0.10
b2'	0.00	0.10
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22

Unit: mm		
Symbol	Min.	Max.
D1	5.30REF	
E	6.40	6.80
E1	4.63	-
e	2.286BSC	
H	16.22	16.82
L1	9.15	9.65
L3	0.88	1.28
L5	1.65	1.95





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